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- *EPIC*[™] (Enhanced-Performance Implanted CMOS) 1-μm Process
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK) and Flatpacks (W), and Standard Plastic (N) and Ceramic (J) DIPS

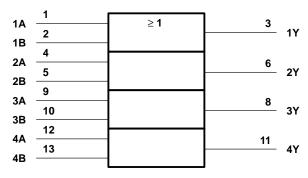
description

The 'AC32 are quadruple 2-input positive-OR gates. The devices perform the Boolean function Y = A + B or $Y = \overline{A} \cdot \overline{B}$ in positive logic.

The SN54AC32 is characterized for operation over the full military temperature range of -55° C to 125° C. The SN74AC32 is characterized for operation from -40° C to 85° C.

FUNCTION TABLE (each gate)								
INPUTS OUTPUT								
Α	В	Y						
Н	Х	Н						
Х	Н	Н						
L	L	L						

logic symbol[†]



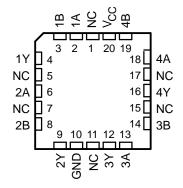
⁺ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, DB, J, N, PW, and W packages.

SN54AC32 . . . J OR W PACKAGE SN74AC32 . . . D, DB, N, OR PW PACKAGE (TOP VIEW)

		$\overline{\mathbf{U}}$	
1A	1	U 14] V _{CC}] 4B
1B	2	13] 4B
1Y	3	12	4A
2A	4	11] 4Y
2B	5	10] 3B
2Y	6	9] 3A
GND	7	8] 3Y

SN54AC32 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram, each gate (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} Input voltage range, V_I (see Note 1) Output voltage range, V_O (see Note 1) Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) Continuous output current, I_O ($V_O = 0$ to V_{CC}) Continuous current through V_{CC} or GND Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2	-0.5 V to V _{CC} + 0.5 V -0.5 V to V _{CC} + 0.5 V ±20 mA ±20 mA ±20 mA ±200 mA 2): D package
	N package 1.1 W
Storage temperature range, T _{stg}	PW package 0.5 W 65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero.

recommended operating conditions (see Note 3)

			SN54/	SN54AC32		AC32	UNIT
			MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage		2	6	2	6	V
		V _{CC} = 3 V	2.1		2.1		
VIH	High-level input voltage	V _{CC} = 4.5 V	3.15		3.15		V
		V _{CC} = 5.5 V	3.85		3.85		
		V _{CC} = 3 V		0.9		0.9	
VIL	IL Low-level input voltage	V _{CC} = 4.5 V		1.35		1.35	V
		$V_{CC} = 5.5 V$		1.65		1.65	
VI	Input voltage		0	VCC	0	VCC	V
VO	Output voltage		0	VCC	0	VCC	V
		V _{CC} = 3 V		-12		-12	
ЮН	High-level output current	V _{CC} = 4.5 V		-24		-24	mA
		V _{CC} = 5.5 V		-24		-24	
		V _{CC} = 3 V		12		12	
IOL	Low-level output current	V _{CC} = 4.5 V		24		24	mA
		V _{CC} = 5.5 V		24		24	
$\Delta t/\Delta v$	Input transition rise or fall rate		0	8	0	8	ns/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



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	TEST CONDITIONS		Т	A = 25°C	;	SN54	AC32	SN74	AC32	LINUT	
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
		3 V	2.9			2.9		2.9			
	I _{OH} = -50 μA	4.5 V	4.4			4.4		4.4			
		5.5 V	5.4			5.4		5.4			
Vou	I _{OH} = – 12 mA	3 V	2.56			2.4		2.46			
VOH	I _{OH} = – 24 mA	4.5 V	3.86			3.7		3.76		v	
	OH = -24 IIIA	5.5 V	4.86			4.7		4.76			
	I _{OH} = - 50 mA [†]					3.85					
	I _{OH} = – 75 mA [†]	5.5 V						3.85			
		3 V		0.002	0.1		0.1		0.1		
	I _{OL} = 50 μA	4.5 V		0.001	0.1		0.1		0.1		
		5.5 V		0.001	0.1		0.1		0.1		
	I _{OL} = 12 mA	3 V			0.36		0.5		0.44	V	
VOL	la: 04 mA	4.5 V			0.36		0.5		0.44		
	I _{OL} = 24 mA	5.5 V			0.36		0.5		0.44		
	I _{OL} = 50 mA [†]	5.5 V					1.65				
	$I_{OL} = 75 \text{ mA}^{\dagger}$								1.65		
II A or B ports	$V_{I} = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μΑ	
Icc	$V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$	5.5 V			2		40		20	μΑ	
Ci	$V_{I} = V_{CC}$ or GND	5 V		2.6						pF	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

[†]Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V $\pm\,$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM TO	TO T _A = 25°C		;	SN54AC32		SN74AC32		UNIT	
FARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
^t PLH	A or B	v	1.5	7	9	1	12	1.5	10	
^t PHL		I	1.5	7	8.5	1	11.5	1	9	ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V $\pm\,$ 0.5 V (unless otherwise noted) (see Figure 1)

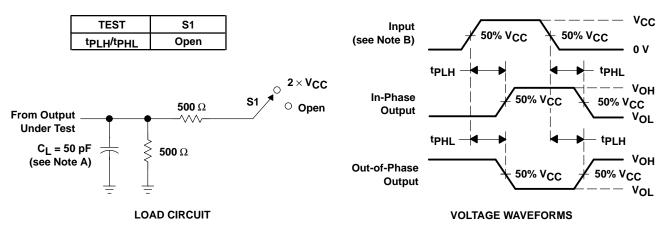
PARAMETER	FROM TO		T,	ן = 25°C	;	SN54	AC32	SN74	AC32	UNIT
FARAWETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
^t PLH	A or B	A or B X	1.5	5.5	7.5	1	9	1	8.5	
^t PHL		ſ	1.5	5	7	1	8.5	1	7.5	ns

operating characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd} Power dissipation capacitance	$C_L = 50 \text{ pF}, \text{ f} = 1 \text{ MHz}$	40	pF



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PARAMETER MEASUREMENT INFORMATION

NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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